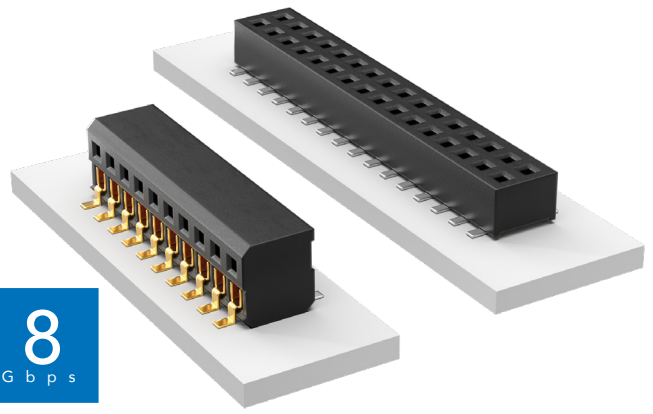


# LOW PROFILE DUAL WIPE SOCKET

(1.27 mm) .050" PITCH • CLP SERIES



**CLP**  
**Mates:**  
FTSH, FTS, FW

CLP	1	NO. PINS PER ROW	02	PLATING OPTION	ROW OPTION	OTHER OPTIONS
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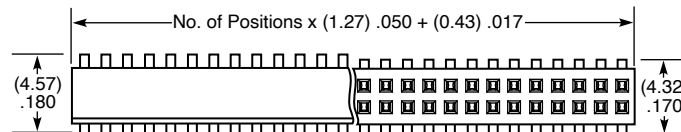
02 thru 50

## SPECIFICATIONS

**Insulator Material:**  
Black Liquid Crystal Polymer  
**Contact Material:**  
Phosphor Bronze  
**Plating:**  
Sn or Au over  
50 μ" (1.27 μm) Ni  
**Operating Temp Range:**  
-55 °C to +125 °C  
**Current Rating (CLP/FTSH):**  
3.4 A per pin  
(2 pins powered)  
**Voltage Rating:**  
280 VAC/396 VDC  
**Insertion Depth:**  
Top Entry =  
(1.40 mm) .055" minimum  
Bottom Entry =  
(2.41 mm) .095" minimum  
plus board thickness  
DH Entry =  
(2.31 mm) .091" to (2.67 mm) .105"  
**Max Cycles:**  
100 with 10 μ" (0.25 μm) Au

## PROCESSING

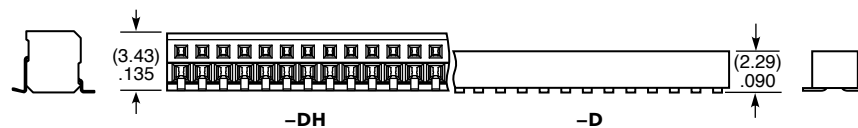
**Lead-Free Solderable:**  
Yes  
**SMT Lead Coplanarity:**  
(0.10 mm) .004" max (02-35)  
(0.15 mm) .006" max (36-50)\*  
\*(.004" stencil solution  
may be available; contact  
ipg@samtec.com)



## ALSO AVAILABLE

Contact Samtec

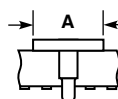
Single row  
Other platings



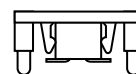
**Notes:**  
Severe Environment  
Testing qualified; aligns  
with MIL-DTL-55302.  
Visit [samtec.com/set](http://samtec.com/set)

Some lengths, styles and  
options are non-standard,  
non-returnable.

PIN/ROW	A
04-15	(3.56) .140
16-50	(7.11) .280



If odd pins/row, alignment pins are on  
middle position on centerline of the part.  
If even pins/row, then alignment pins are  
between middle two positions.



-PA OPTION



-P OPTION